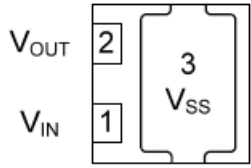
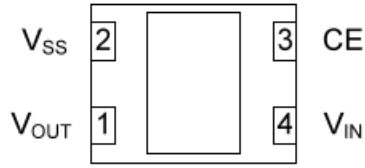


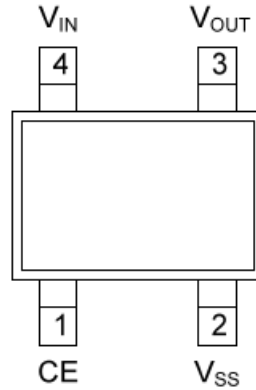
■ PIN CONFIGURATION



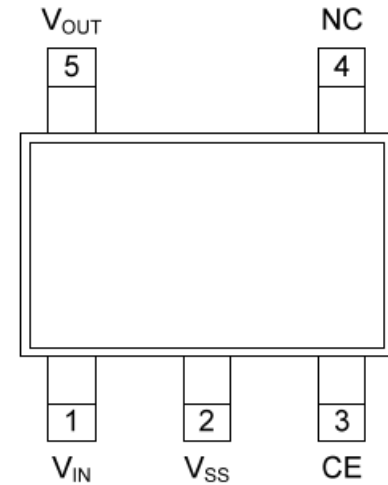
USP-3
(BOTTOM VIEW)



USP-4
(BOTTOM VIEW)



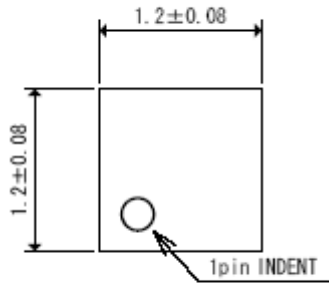
SSOT-24
(TOP VIEW)



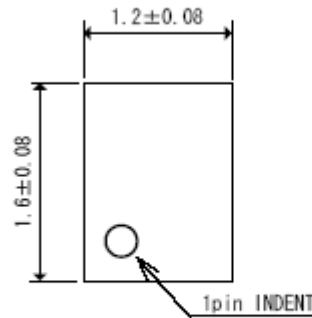
SOT-25
(TOP VIEW)

*The heat dissipation pad of the USP-4 package is recommended to solder as the recommended mount pattern and metal mask pattern for mounting strength. The mount pattern should be electrically opened or connected to the V_{SS} (No.2) pin.

● USP-3



● USP-4



● SSOT-24

